

A $30.1\mu\text{m}^2$, $< \pm 1.1^\circ\text{C}$ - 3σ -Error, 0.4-to-1.0V Temperature Sensor based on Direct Threshold- Voltage Sensing for On-Chip Dense Thermal Monitoring

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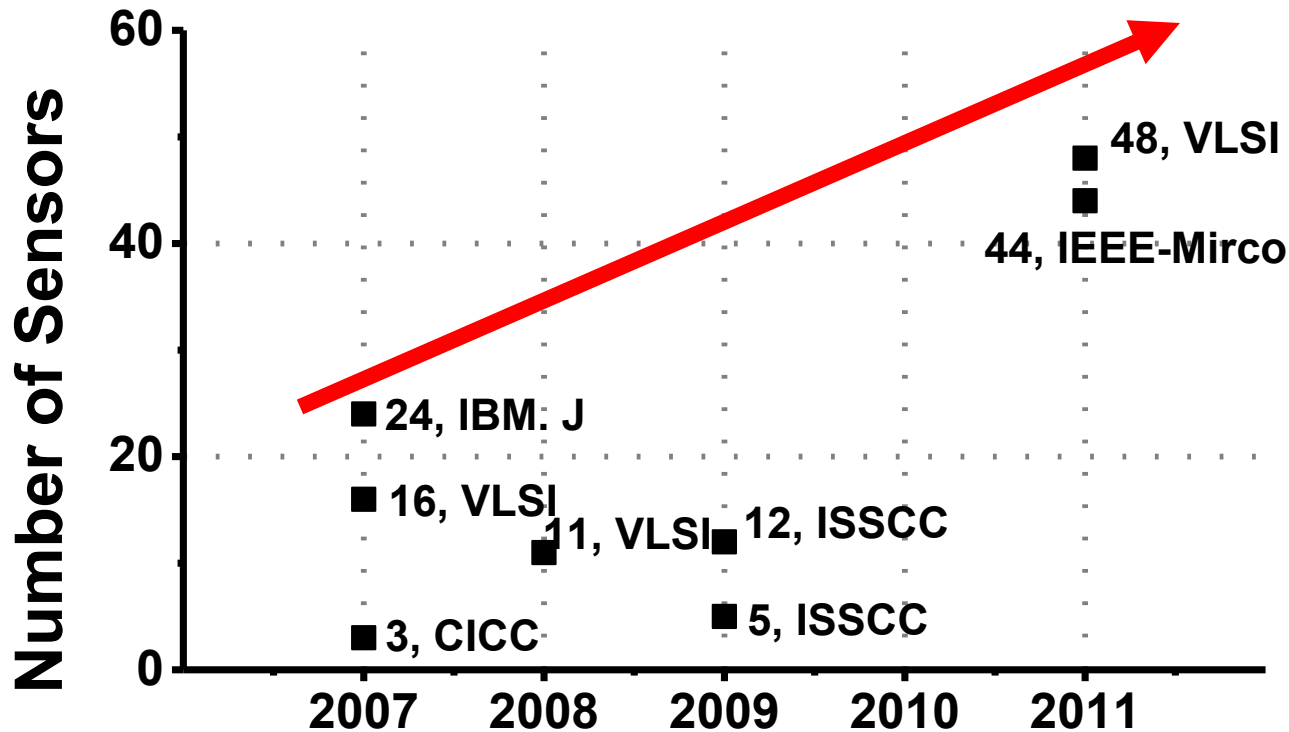
Outline

- Motivation and Design Requirements
- Proposed Temperature Sensor
- Chip Design
- Measurement Results
- Conclusion

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Motivation



- Dynamic thermal management (DTM)
 - Address thermal hotspots, manage power...
- Trends show an increasing # of sensors on a chip

Design Requirement

■ Small area

- Trends require more # of sensors on a chip
 - Multi-core, 3D-ICs...
 - DTM efficiency improves with more # of sensors
- Flexibility in placement; easily move and place sensors later in design phases

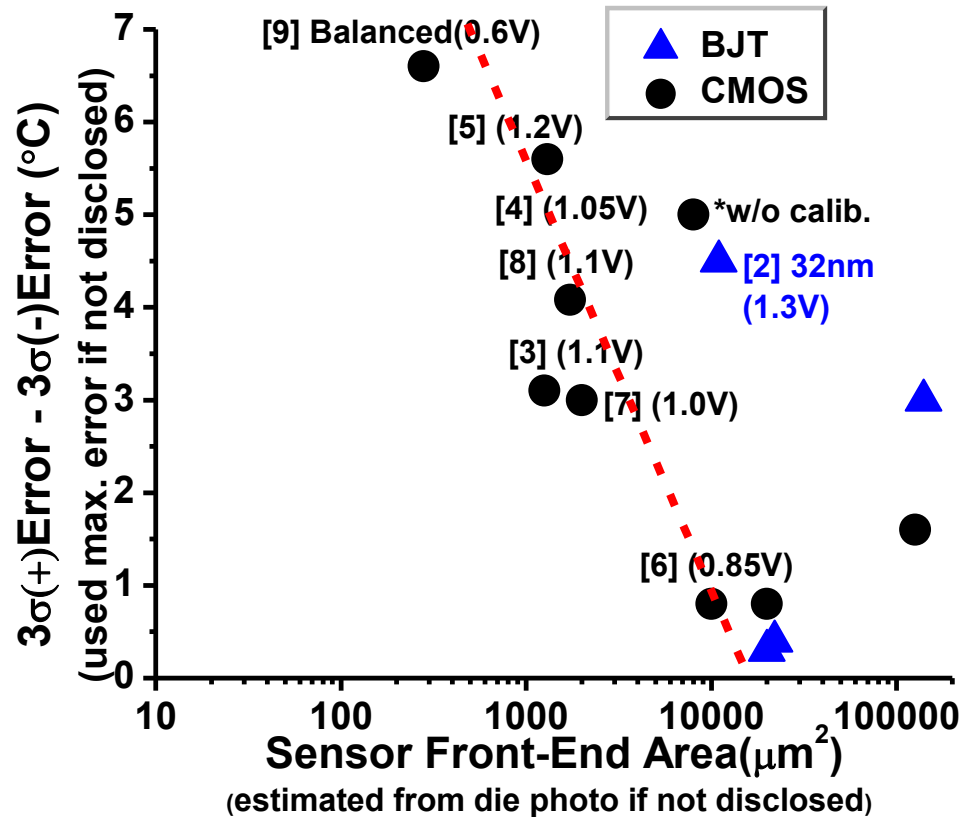
■ Accuracy

- DTM efficiency directly impacted by accuracy of each temperature sensor

■ Voltage scalability

- Commonly use dynamic voltage and frequency scaling (DVFS)
 - Ultra-dynamic voltage scaling (UDVS)

Motivation

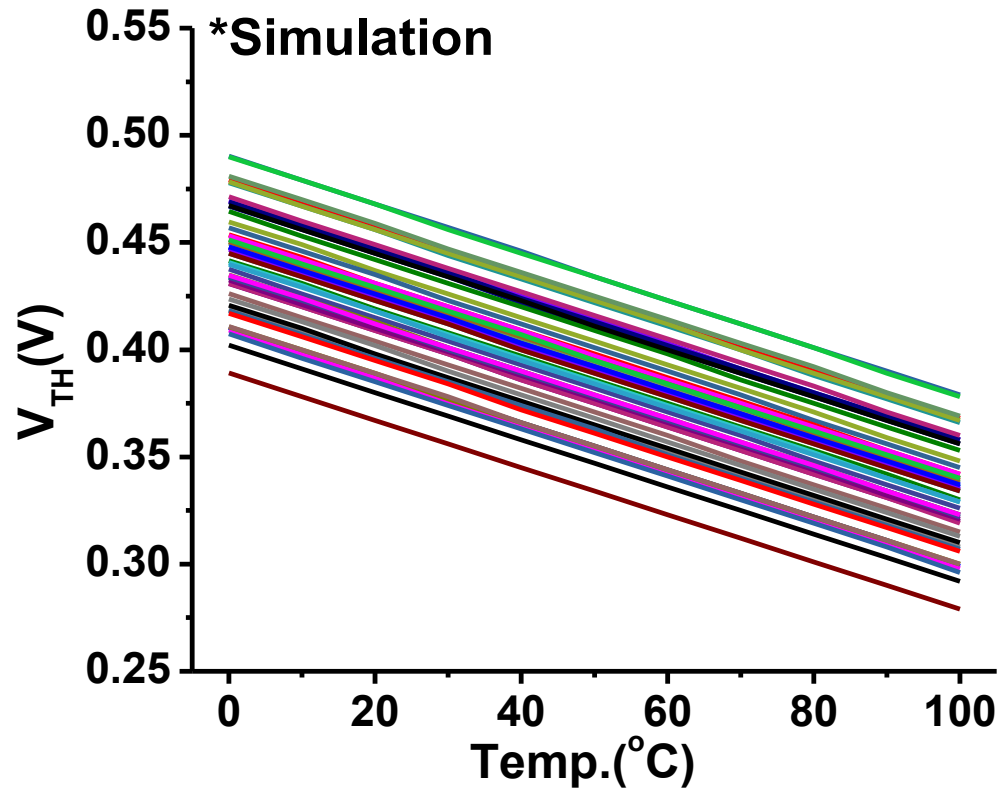


- Trade-off between area and accuracy due to inevitable process variation, particularly mismatch
- Previous BJT-based sensors have limited voltage scalability

Outline

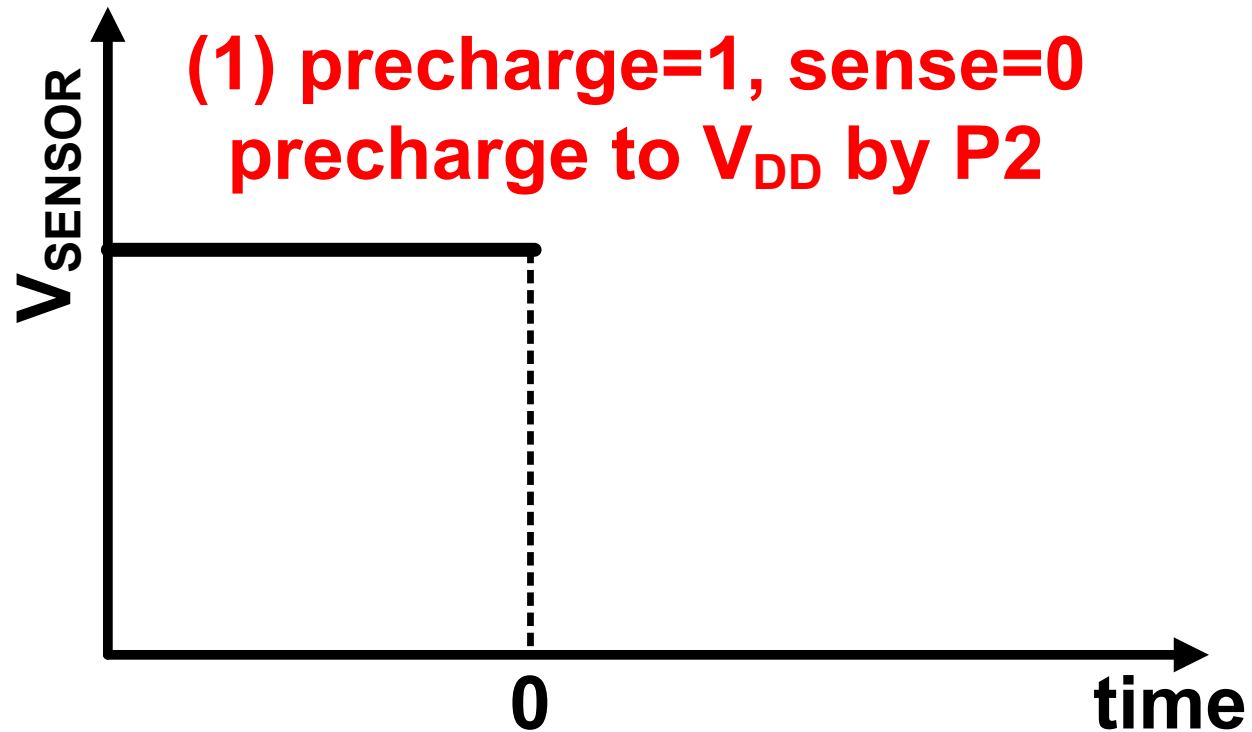
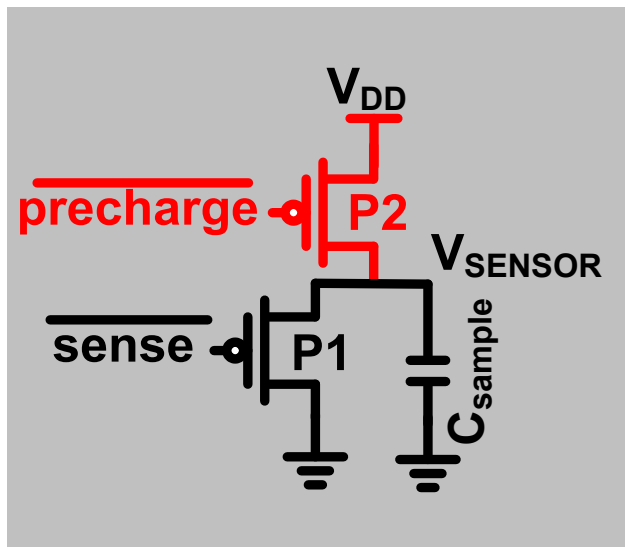
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Temperature Dependency of V_{TH}



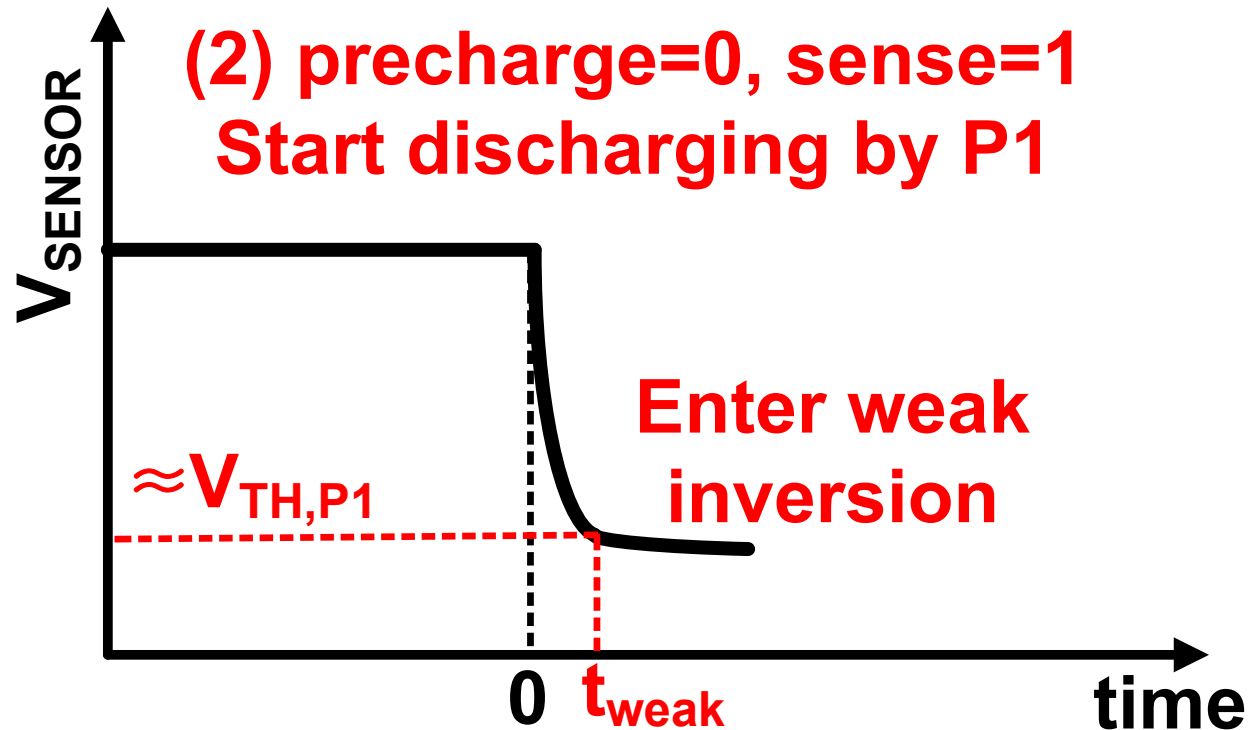
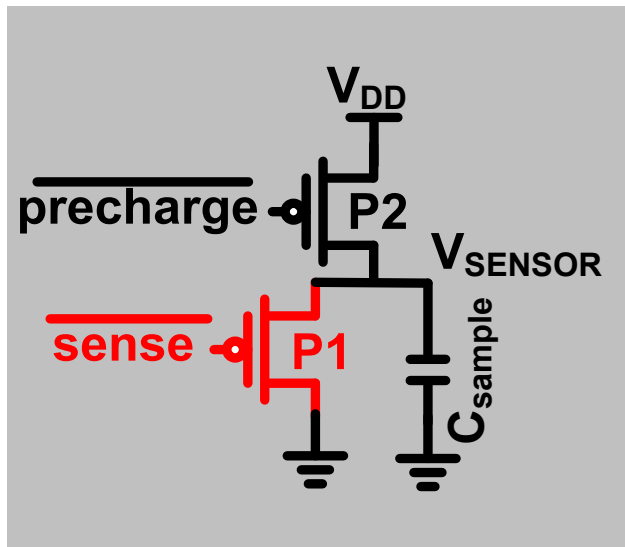
- $V_{TH}(T) = V_{TH}(T_{ROOM}) + K_{VTH}(T - T_{ROOM})$
- $K_{VTH} = -1.12\text{mV}/^{\circ}\text{C}$, stable against process variation
- Linearity $R^2 > 0.9999$
- Well-suited for one-point-calibration (OPC)

Proposed Temperature Sensor



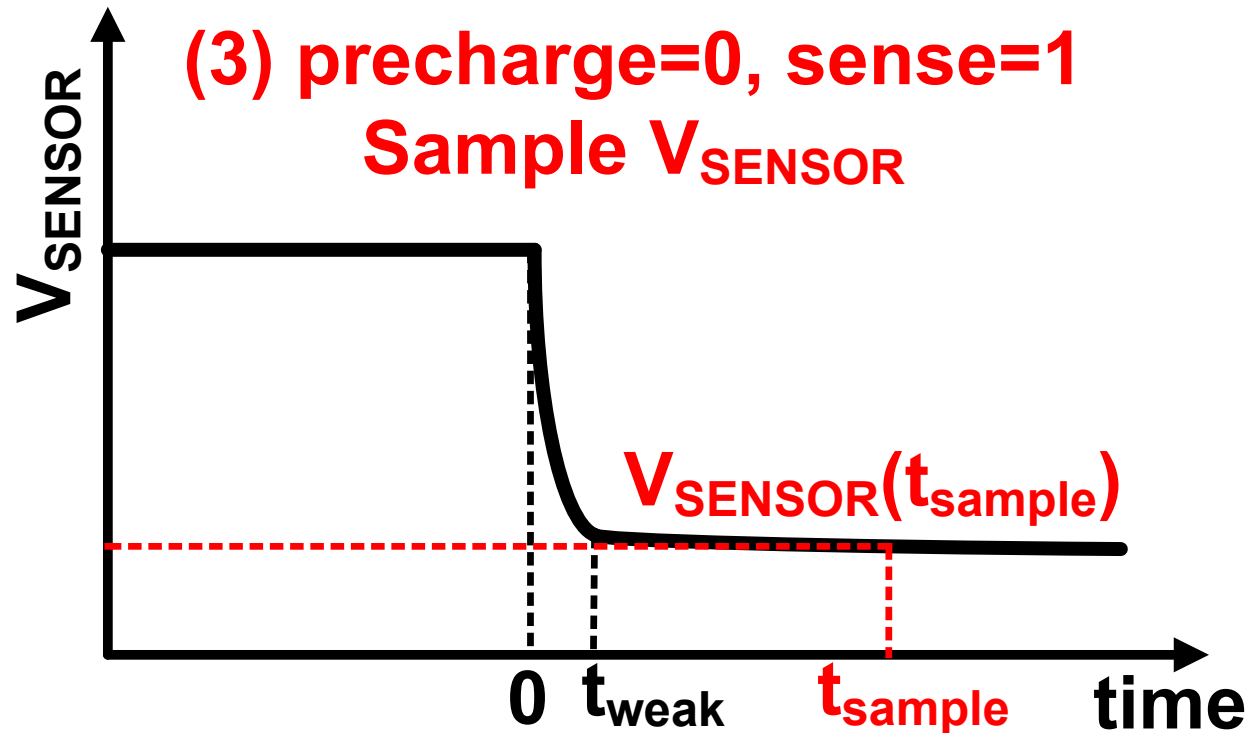
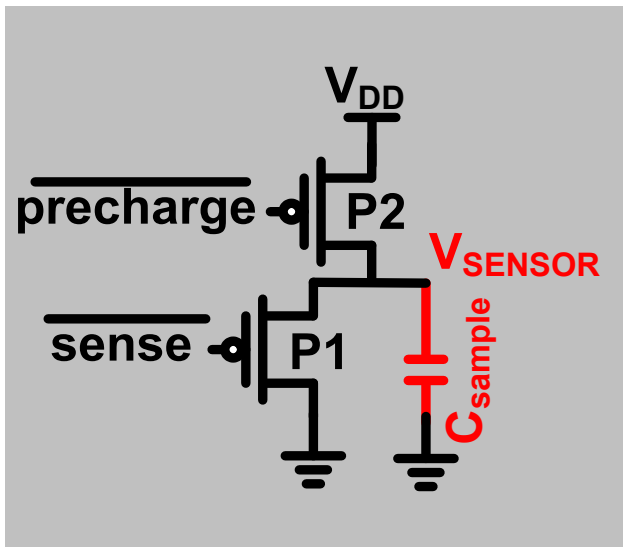
- Pre-charge PMOS P2

Proposed Temperature Sensor



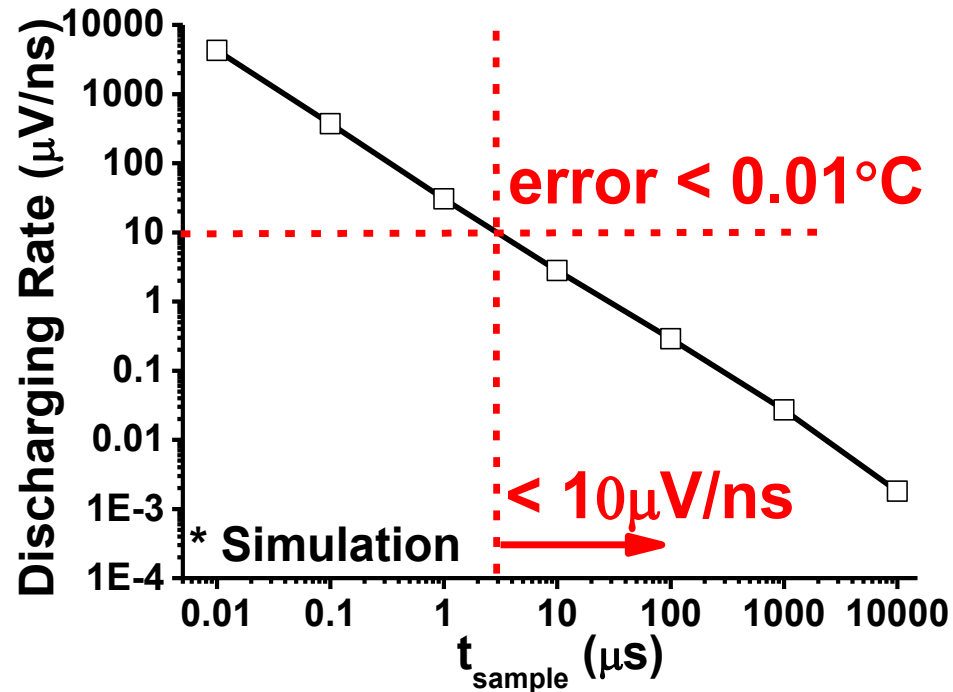
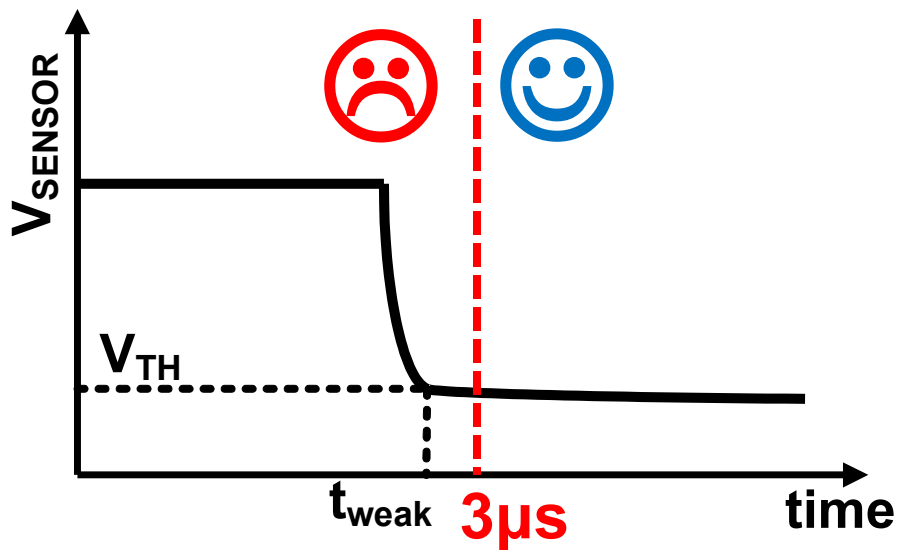
- Sensing transistor P1
 - Based on the dynamics often called V_{TH} drop
 - Use the temperature dependency of $V_{TH,P1}$ for temperature sensing

Proposed Temperature Sensor



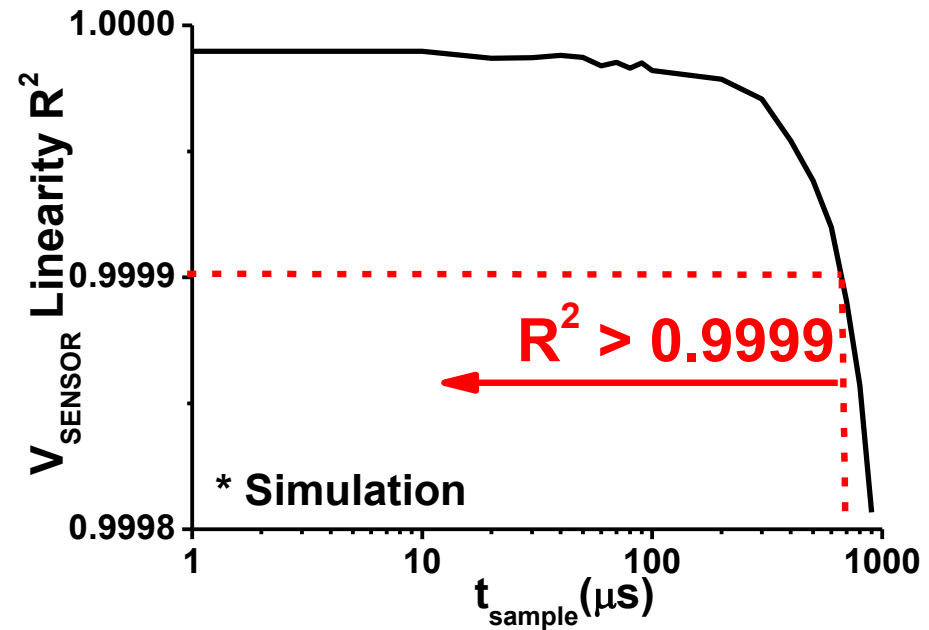
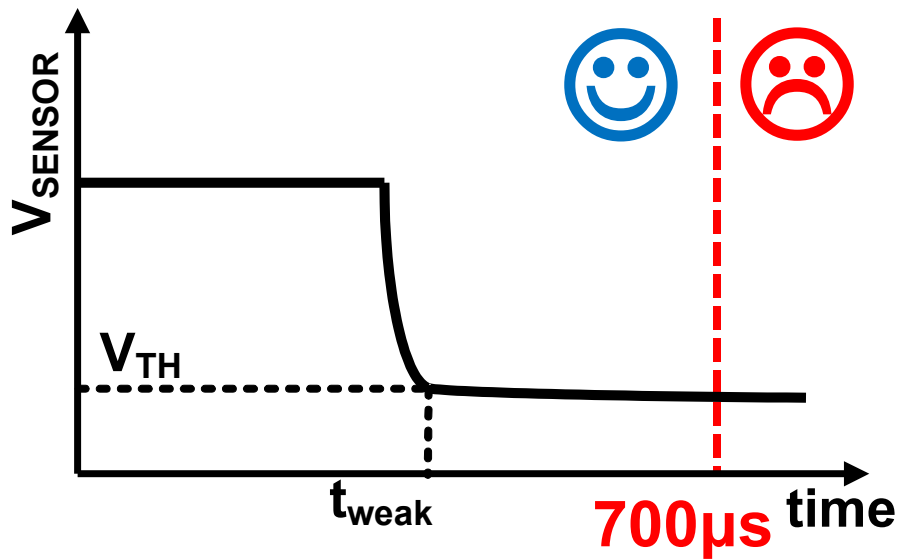
- Wait and sample V_{SENSOR} at the optimal t_{sample}
- Sampling at optimal t_{sample} important for achieving high accuracy

Optimal t_{sample}



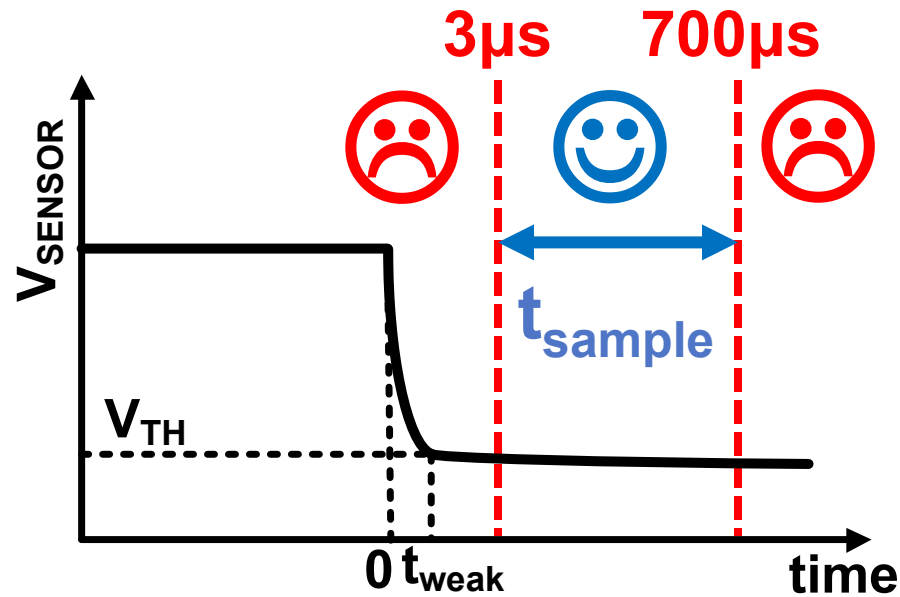
- Lower bound condition
- Low discharging rate is good against timing variation
 - E.g. t_{sample} variability due to PVT variations

Optimal t_{sample}



- Upper bound condition
- Sampling too late can degrade linearity since leakage plays a bigger role

Optimal t_{sample}



$$V_{\text{SENSOR}}(t_{\text{sample}}) = V_{\text{TH}} - \frac{I_{\text{weak}} \cdot (t_{\text{sample}} - t_{\text{weak}})}{C_{\text{sample}}}$$

- Optimal sampling time: $3\mu\text{s} < t_{\text{sample}} < 700\mu\text{s}$

Optimal t_{sample}

$$V_{\text{SENSOR}}(t_{\text{sample}}) = V_{\text{TH}} - \frac{I_{\text{weak}}}{C_{\text{sample}}} (t_{\text{sample}} - t_{\text{weak}})$$

$$V_{\text{TH}}(T) = V_{\text{TH}}(T_{\text{ROOM}}) + K_{\text{VTH}}(T - T_{\text{ROOM}})$$

V_{TH} is linear with temperature

$$\approx t_{\text{sample}} (\because t_{\text{sample}} \gg t_{\text{weak}})$$

$$t_{\text{weak}} = 100\text{ns}, t_{\text{sample}} = 3\mu\text{s} - 700\mu\text{s}$$

Optimal t_{sample}

$$V_{\text{SENSOR}}(t_{\text{sample}}) = V_{\text{TH}} - \frac{I_{\text{weak}} \cdot t_{\text{sample}}}{C_{\text{sample}}}$$

$$I_{\text{weak}} \approx \mu_0 \cdot \left(\frac{T}{T_{\text{room}}} \right)^{-k_u} \cdot C_{\text{ox}} \cdot \frac{W}{L} \cdot (n-1) \cdot \left(\frac{KT}{q} \right)^2 \cdot \exp \left(\frac{V_{\text{GS}} - V_{\text{TH}}(T)}{nV_T} \right)$$

Optimal t_{sample}

$$V_{\text{SENSOR}}(t_{\text{sample}}) = V_{\text{TH}} - \frac{I_{\text{weak}} \cdot t_{\text{sample}}}{C_{\text{sample}}}$$

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$V_{\text{GS}} \approx V_{\text{TH}}(T)$

$$\approx \mu_0 \cdot C_{\text{ox}} \cdot \frac{W}{L} \cdot (n-1) \cdot \left(\frac{K}{q} \right)^2 \cdot T_{\text{room}}^{k_u} \cdot T^{K_0}$$

$K_0 = -k_u + 2$

Optimal t_{sample}

$$V_{\text{SENSOR}}(t_{\text{sample}}) = V_{\text{TH}} - \frac{I_{\text{weak}} \cdot t_{\text{sample}}}{C_{\text{sample}}}$$

$$I_{\text{weak}} \approx \mu_0 \cdot \left(\frac{T}{T_{\text{room}}} \right)^{-k_u} \cdot C_{\text{ox}} \cdot \frac{W}{L} \cdot (n-1) \cdot \left(\frac{KT}{q} \right)^2 \cdot \exp \left(\frac{V_{\text{GS}} - V_{\text{TH}}(T)}{nV_T} \right)$$

$$\approx \mu_0 \cdot C_{\text{ox}} \cdot \frac{W}{L} \cdot (n-1) \cdot \left(\frac{K}{q} \right)^2 \cdot T_{\text{room}}^{k_u} \cdot T^{K_0}$$

$$\approx C \cdot T_{\text{room}}^{k_u + k_0} \cdot \left(1 + \frac{T - T_{\text{room}}}{T_{\text{room}}} \right)^{k_0}$$

Optimal t_{sample}

$$V_{\text{SENSOR}}(t_{\text{sample}}) = V_{\text{TH}} - \frac{I_{\text{weak}} \cdot t_{\text{sample}}}{C_{\text{sample}}}$$

$$I_{\text{weak}} \approx \mu_0 \cdot \left(\frac{T}{T_{\text{room}}} \right)^{-k_u} \cdot C_{\text{ox}} \cdot \frac{W}{L} \cdot (n-1) \cdot \left(\frac{KT}{q} \right)^2 \cdot \exp \left(\frac{V_{\text{GS}} - V_{\text{TH}}(T)}{nV_T} \right)$$

$$\approx \mu_0 \cdot C_{\text{ox}} \cdot \frac{W}{L} \cdot (n-1) \cdot \left(\frac{K}{q} \right)^2 \cdot T_{\text{room}}^{k_u} \cdot T^{K_0}$$

$$\approx C \cdot T_{\text{room}}^{k_u+k_0} \cdot \left(1 + \frac{T - T_{\text{room}}}{T_{\text{room}}} \right)^{k_0} \longleftarrow \frac{T - T_{\text{room}}}{T_{\text{room}}} = -0.1 \sim 0.23 \ll 1$$

$$\approx C \cdot T_{\text{room}}^{k_u+k_0} \cdot \left(1 + k_0 \frac{T - T_{\text{room}}}{T_{\text{room}}} \right) \longleftarrow \text{Taylor Series}$$

Optimal t_{sample}

$$V_{\text{SENSOR}}(t_{\text{sample}}) = V_{\text{TH}} - \frac{I_{\text{weak}} \cdot t_{\text{sample}}}{C_{\text{sample}}}$$

$$I_{\text{weak}} \approx \mu_0 \cdot \left(\frac{T}{T_{\text{room}}} \right)^{-k_u} \cdot C_{\text{ox}} \cdot \frac{W}{L} \cdot (n-1) \cdot \left(\frac{KT}{q} \right)^2 \cdot \exp \left(\frac{V_{\text{GS}} - V_{\text{TH}}(T)}{nV_T} \right)$$

$$\approx \mu_0 \cdot C_{\text{ox}} \cdot \frac{W}{L} \cdot (n-1) \cdot \left(\frac{K}{q} \right)^2 \cdot T_{\text{room}}^{k_u} \cdot T^{K_0}$$

$$\approx C \cdot T_{\text{room}}^{k_u+k_0} \cdot \left(1 + \frac{T - T_{\text{room}}}{T_{\text{room}}} \right)^{k_0}$$

$$\approx C \cdot T_{\text{room}}^{k_u+k_0} \cdot \left(1 + k_0 \frac{T - T_{\text{room}}}{T_{\text{room}}} \right)$$

$$\approx C \cdot T_{\text{room}}^{k_u+k_0} \cdot \left[(1 - k_0) + \frac{k_0}{T_{\text{room}}} T \right]$$

$$\approx A_{\text{weak}} + K_{\text{weak}} T$$

I_{weak} at optimal t_{sample} is linear with temperature

Optimal t_{sample}

$$V_{\text{SENSOR}}(t_{\text{sample}}) = V_{\text{TH}} - \frac{I_{\text{weak}} \cdot (t_{\text{sample}} - t_{\text{weak}})}{C_{\text{sample}}}$$



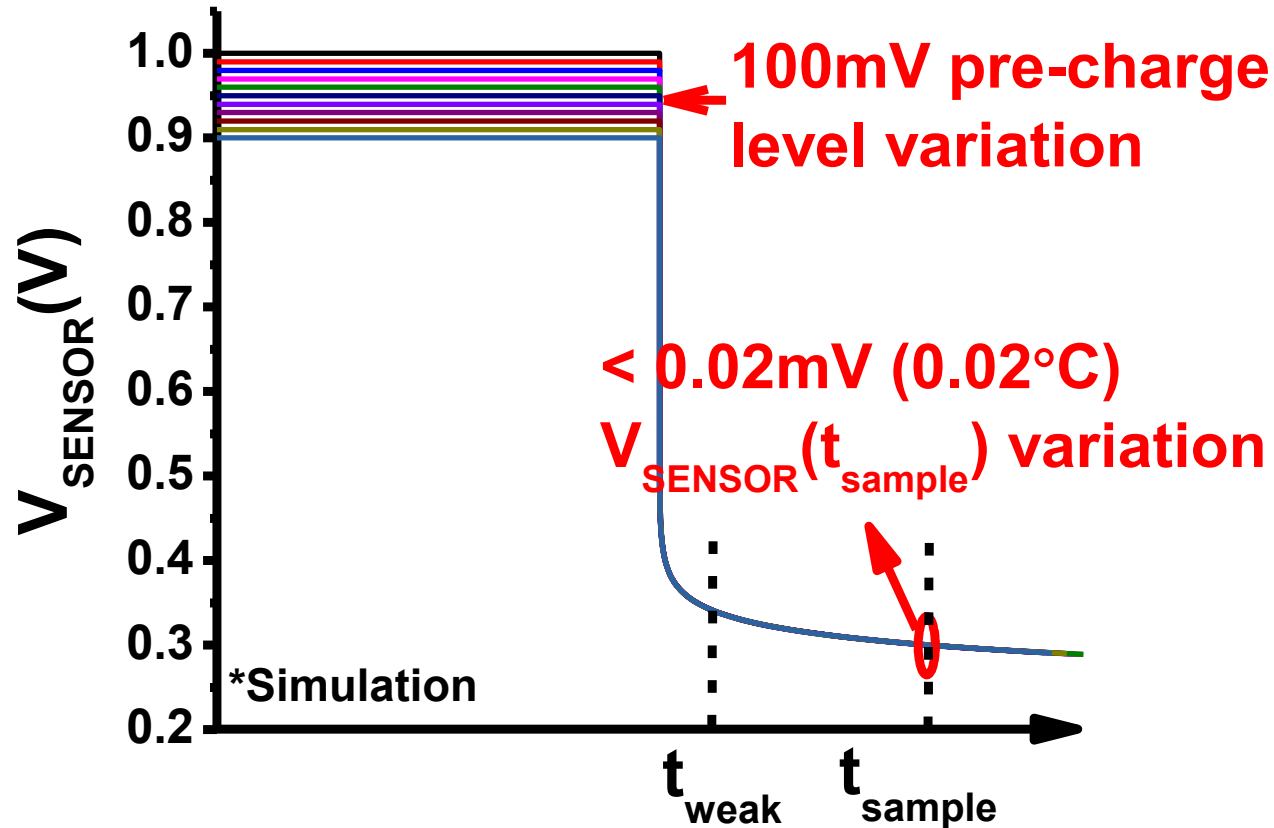
$$V_{\text{SENSOR}}(t_{\text{sample}}) \approx \left[V_{\text{TH}}(T_{\text{room}}) - K_{\text{VTH}} \cdot T_{\text{room}} - \frac{A_{\text{weak}} \cdot t_{\text{sample}}}{C_{\text{sample}}} \right] + \left(K_{\text{VTH}} - \frac{K_{\text{weak}} \cdot t_{\text{sample}}}{C_{\text{sample}}} \right) \cdot T$$

Calibrated via one-point-calibration

Dominant and stable against process variation

Much smaller than K_{VTH}
The variation in $t_{\text{sample}}/C_{\text{sample}}$ makes little impact

Optimal t_{sample}

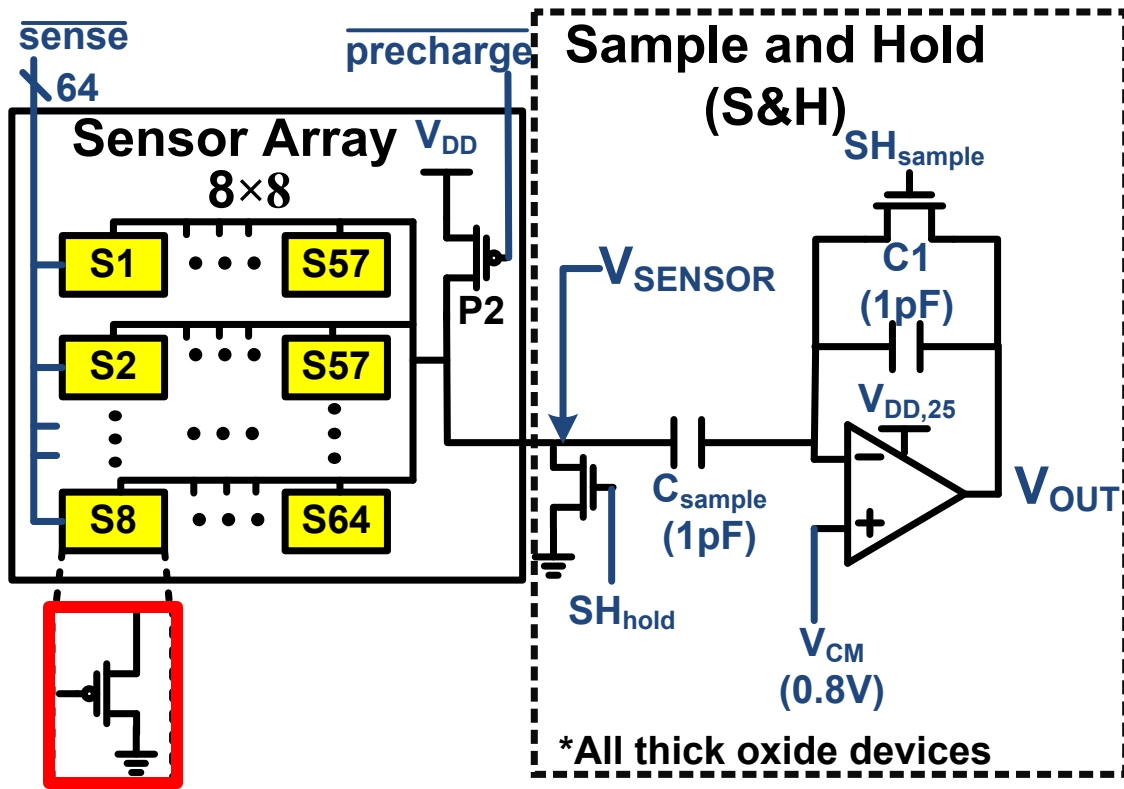


- V_{DD} noise can modulate t_{weak}
- V_{DD} noise has minimal impact since $t_{\text{sample}} \gg t_{\text{weak}}$

Outline

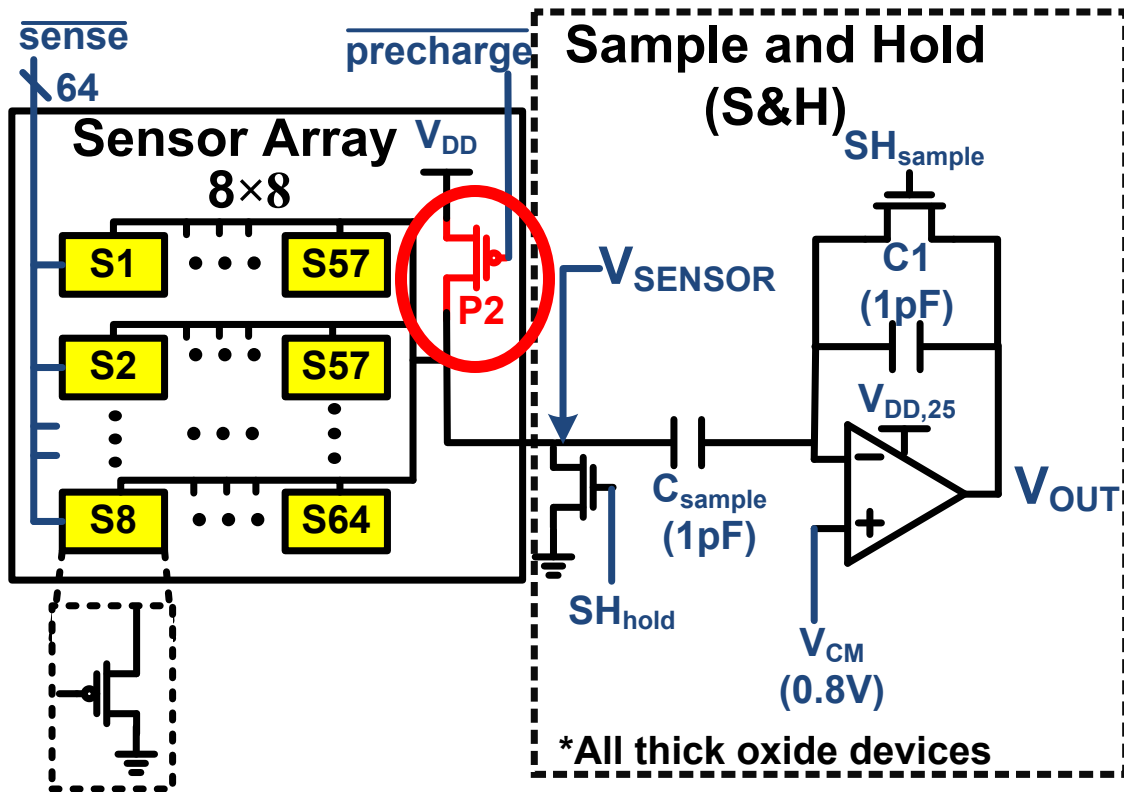
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Chip Design



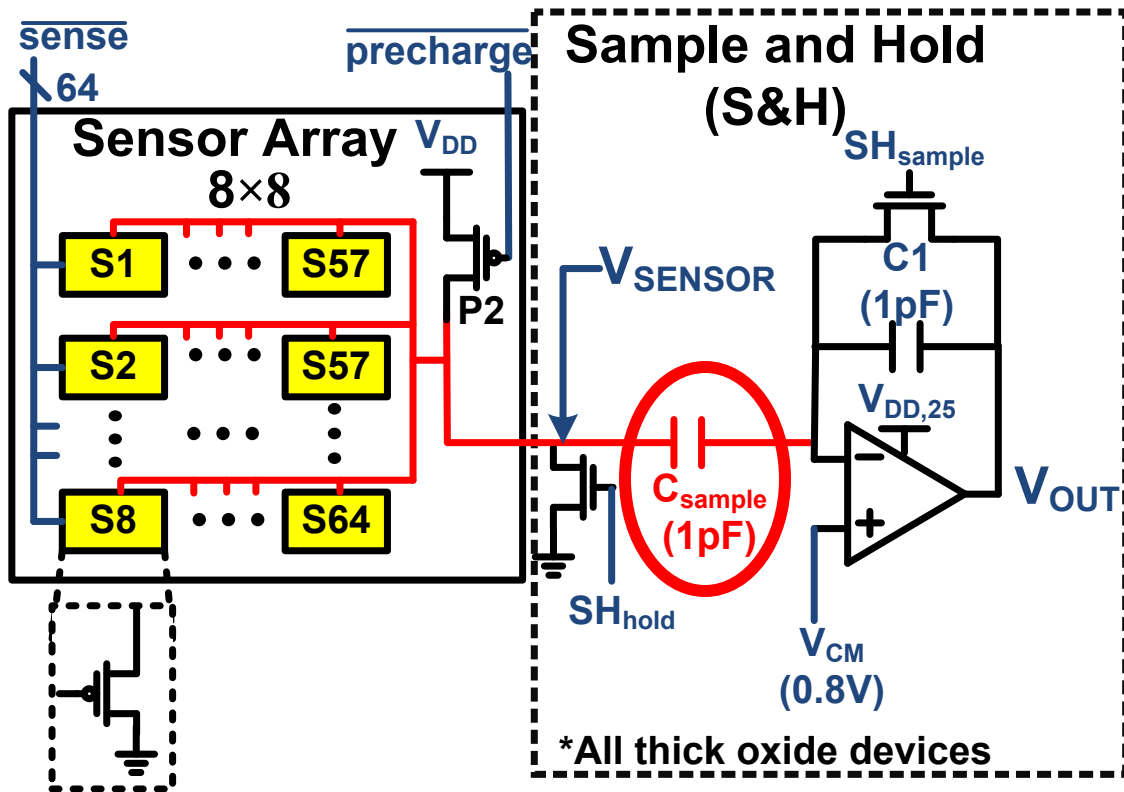
- Unit-size sensor array of 8x8
 - Unit-size sensor uses 3x-min.-sized thick-oxide PMOS
- Multiple unit-size sensors can be combined to form a larger size sensor front end

Chip Design



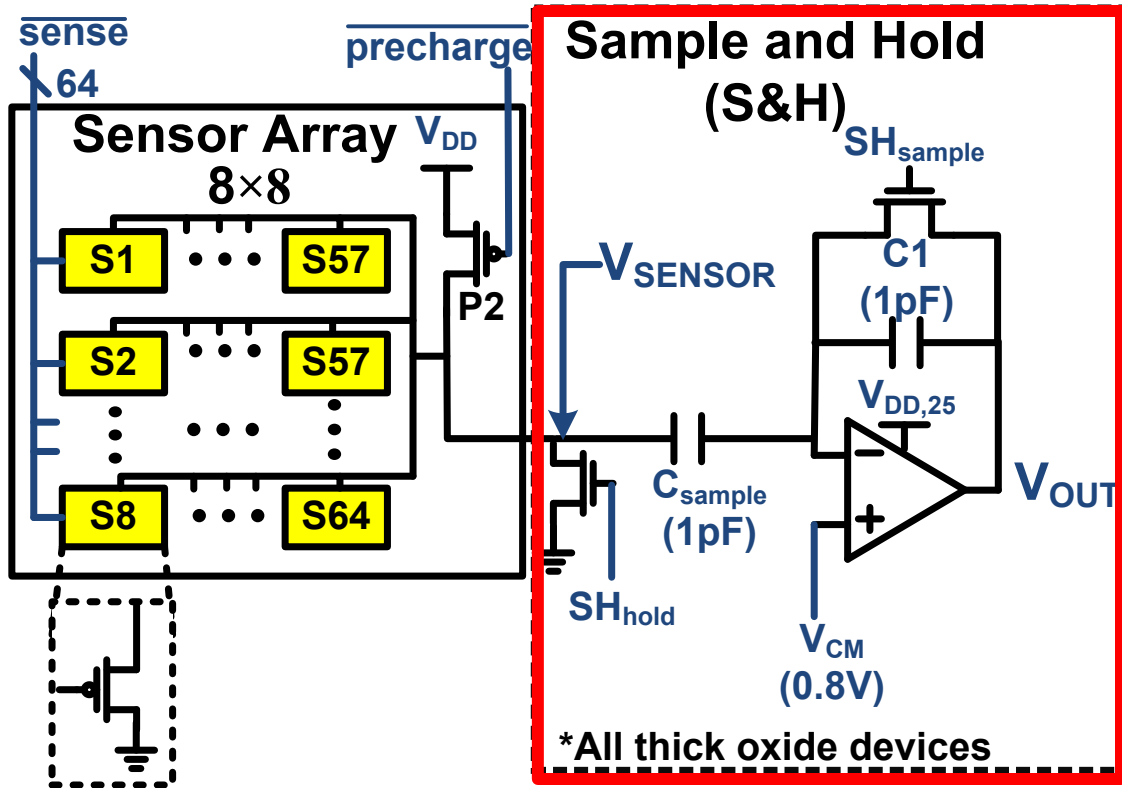
- Pre-charge PMOS (P2) is shared

Chip Design



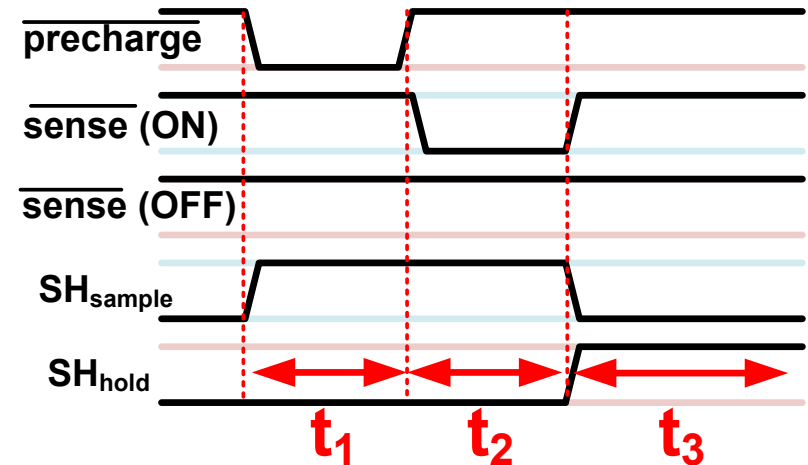
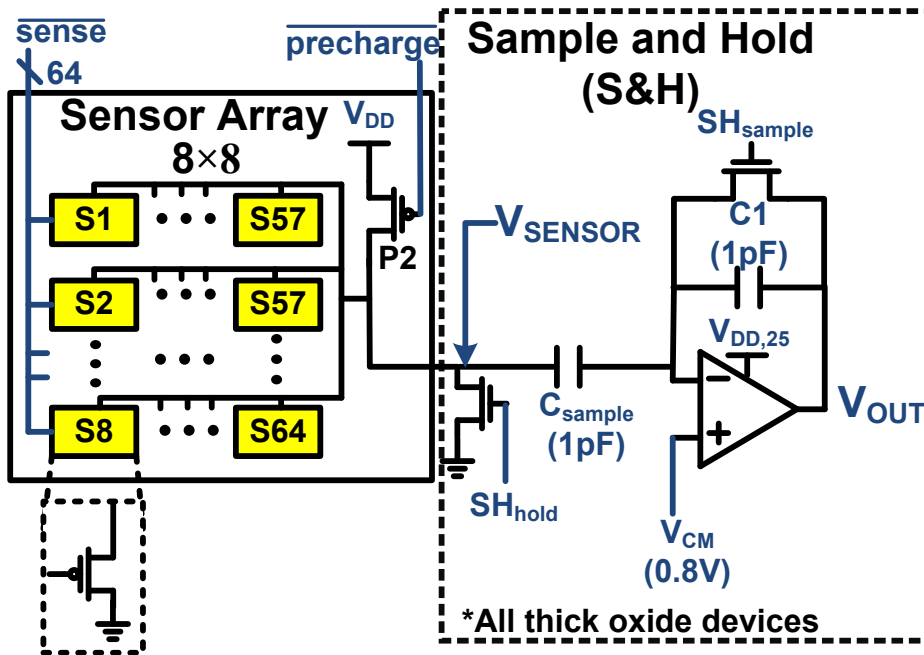
- Sampling capacitor (C_{sample}) is shared
 - ☺ Each sensor sees the identical load capacitance and temperature coefficient (i.e. $K_{V_{TH}} - K_{\text{weak}} t_{\text{sample}} / C_{\text{sample}}$)
 - ☺ Robustness against manufacturing variation
 - ☺ Area savings

Chip Design



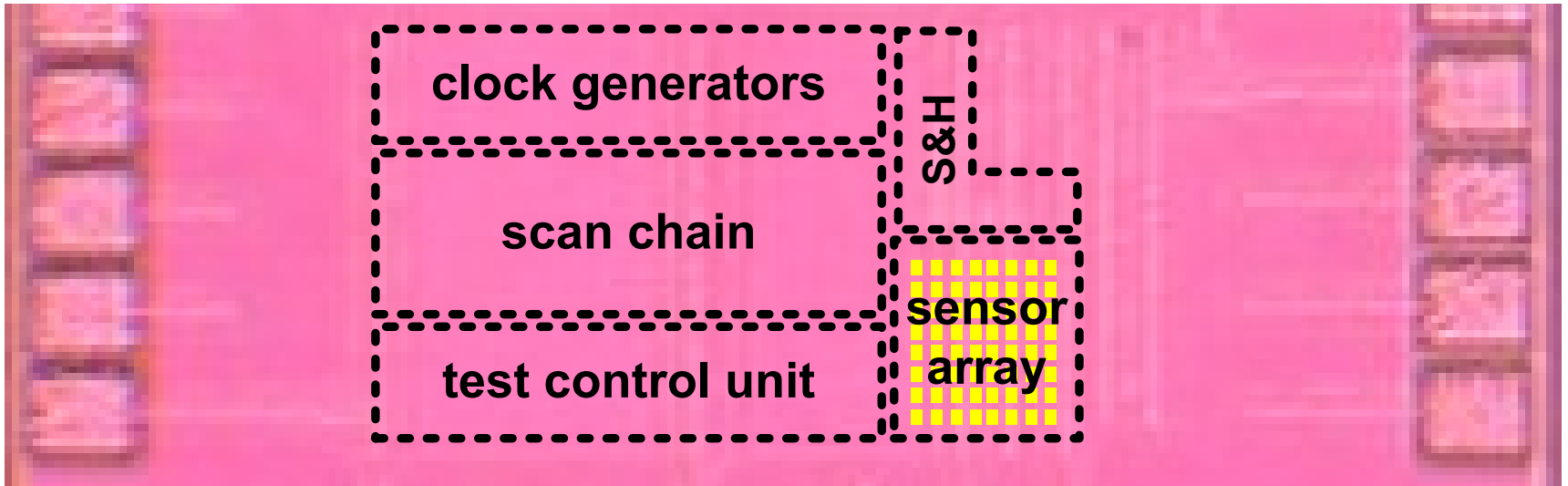
- Sample and hold circuits for off-chip measurement
- V_{OUT} ($V_{SENSOR} + 0.8V$) is digitized with off-chip ADC (16bit, $\pm 5V$)

Chip Design



- **t₁**: pre-charge phase
- **t₂**: sampling phase (=t_{sample})
- **t₃**: S&H captures V_{SENSOR} (t_{sample})

Chip Design

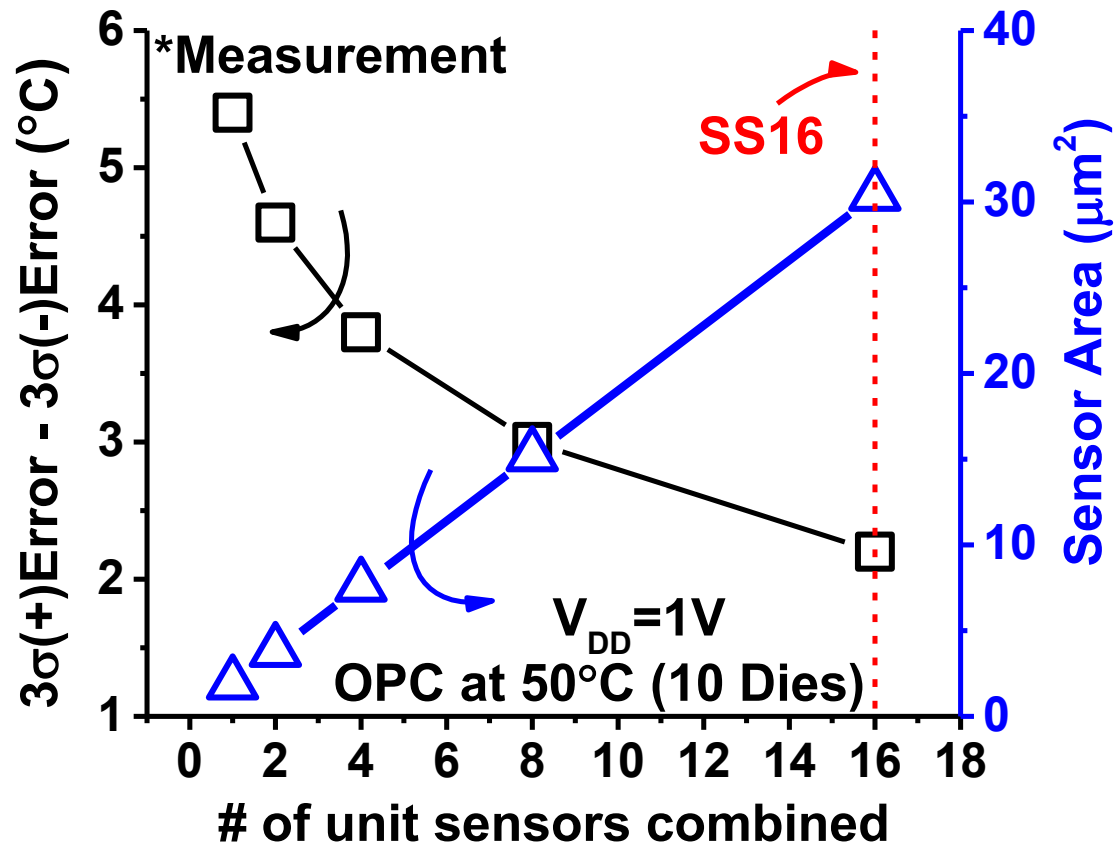


- Test chip die photo
- 65nm CMOS

Outline

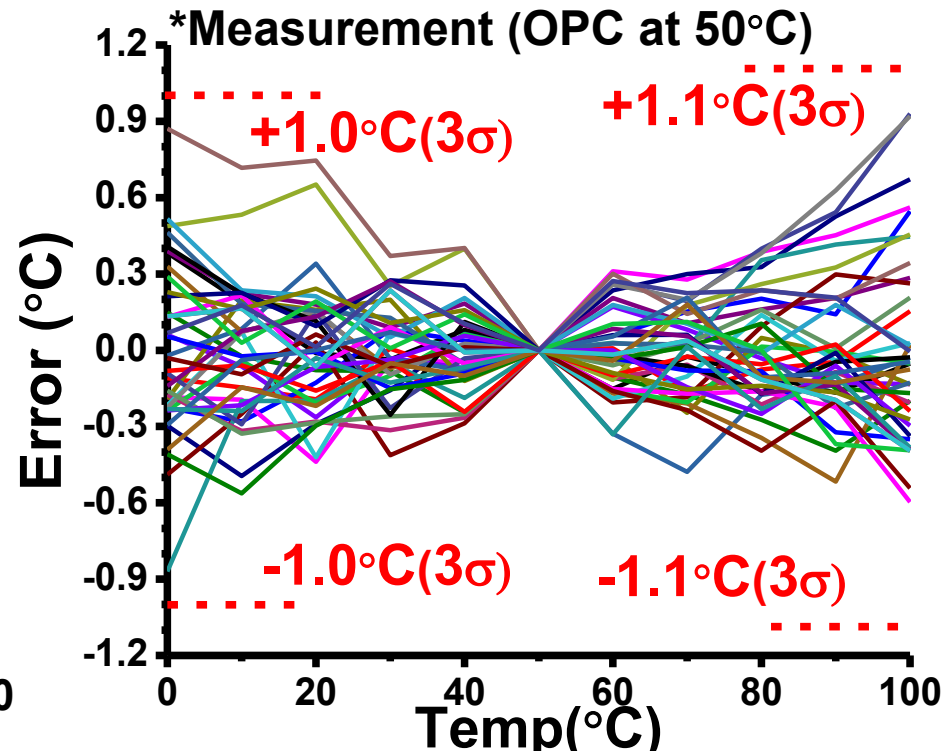
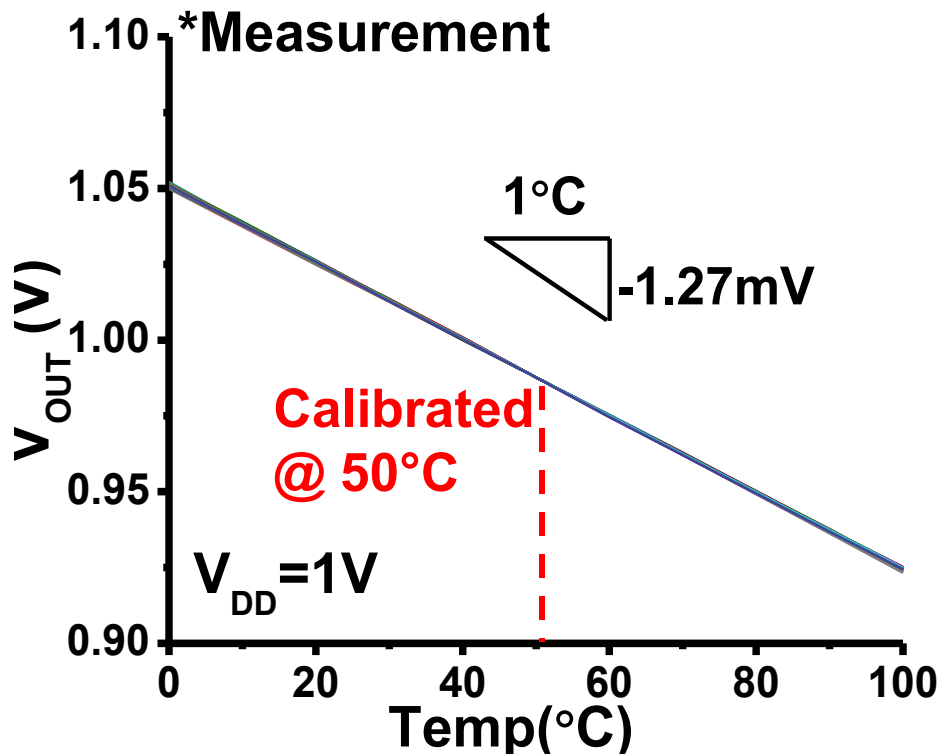
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Measurement Results



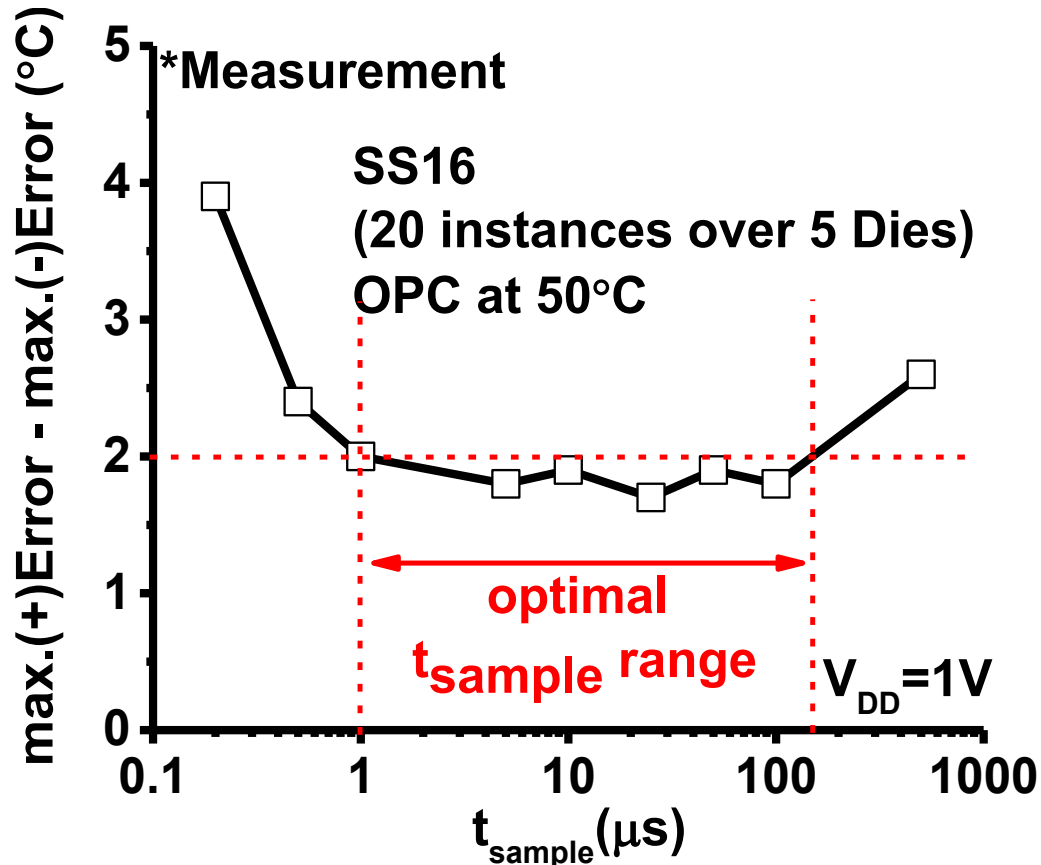
- Accuracy improves with larger sensor size
- Sensor-size-16 (16 unit-size sensors combined)
 - 3σ worst-case error of ±1.1°C after one-point calibration
 - Footprint: 30.1μm²

Measurement Results



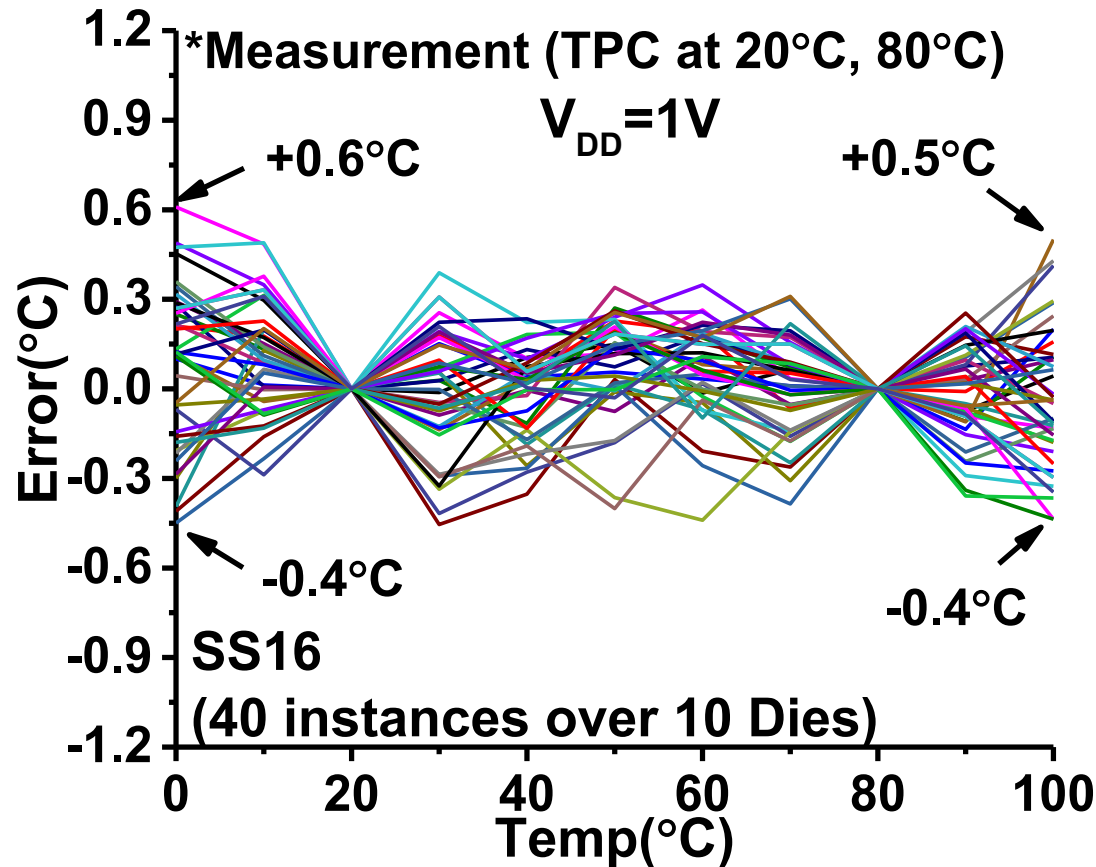
- Sensor-size-16 (SS16, 16 unit-size sensors combined)
- 40 SS16 (10 dies) one-point-calibrated at 50°C
- 3 σ errors of $\pm 1.1^\circ\text{C}$ after one-point-calibration

Measurement Results



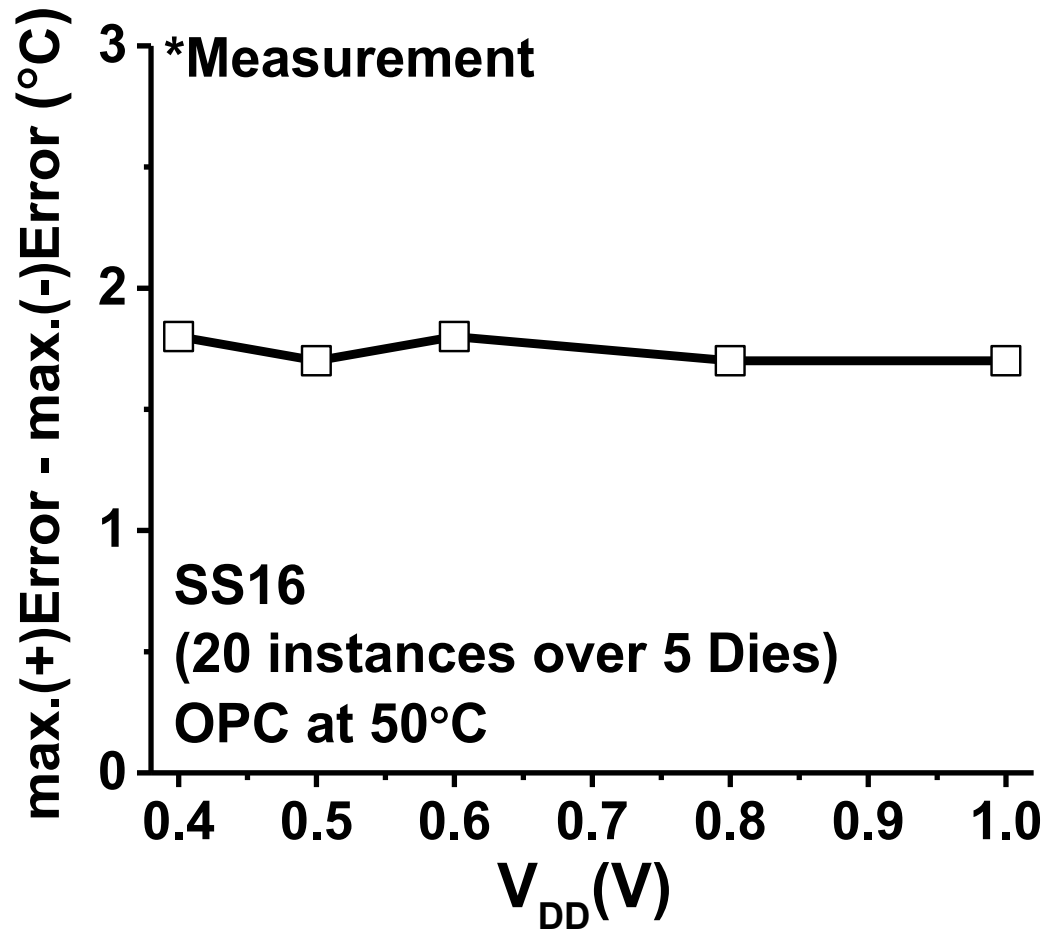
- Opt. t_{sample} range: $1\mu\text{s}$ to $100\mu\text{s}$ for the worst-case error $< 2^\circ\text{C}$
- Sensor sampling rate at $t_1=1\mu\text{s}$, $t_2=10\mu\text{s}$: 91kS/s

Measurement Results



- Two-point-calibration can further reduce the worst-case error to 1°C (-0.4/+0.6°C)

Measurement Results

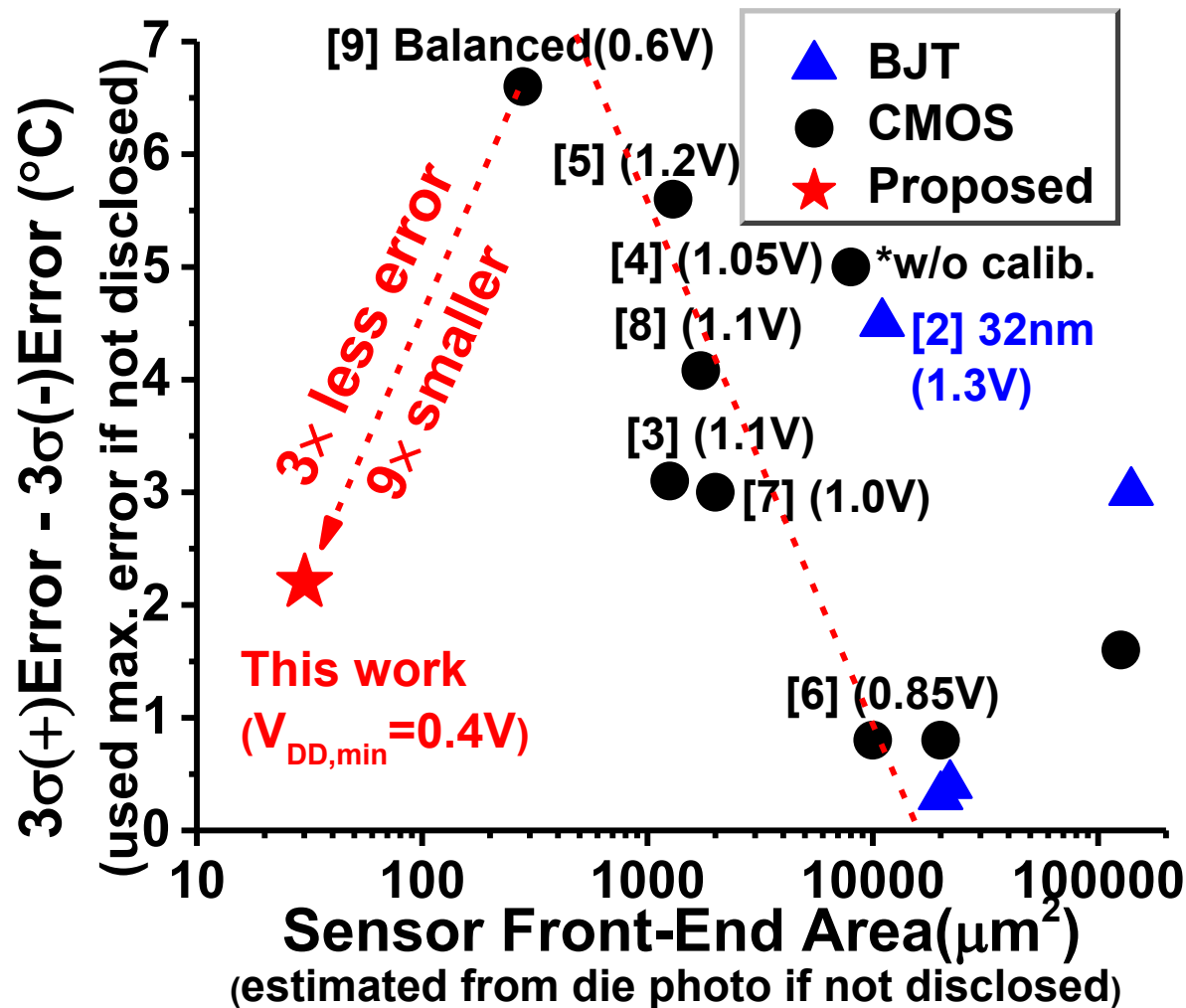


- Voltage scalability down to 0.4V
- Accuracy nearly constant across 0.4-1.0V
 - Using voltage specific TCs for one-point-calibration

Measurement Results

	[2]		[3]	[4]	[5]	[6]	[7]	[8]	[9] Balanced	[10]	Proposed SS16
Tech.	32nm	22nm	65nm	32nm	65nm	160nm	65nm	44nm	65nm	160nm	65nm
Area¹ (μm²)	11000	4000	1255	8000*	1300*	10000*	2000*	1725	280	-	30.1
Area² (μm²)	20000	6100	-	20000	6600	85000	8000	41300	-	4600	-
V_{DD} (V)	1.3-1.8	-	1.1	1.05	1.2	0.85-1.2	1	1.1	0.6~1	1.35	0.4~1
Temperature Coefficient	4.23 [c/°C]	3.82 [c/°C]	-	-	0.68 [mV/°C]	-	-	3.2 [mV/°C]	0.57 [mV/°C]	-	1.27 [mV/°C]
Range (°C)	-10~110		40~90	-10~110	-40~110	-40~125	0~110	0~110	0~100	-10~125	0~100
Error³ (°C)	-	-	-	< 5	-	-	-	-	-	±6.5(3σ)	-
Error⁴ (°C)	<4.5	-	<3.1	-	-2.7~2.9	±0.4(3σ)	±1.5(3σ)	-1.4~2.7	-3.4~3.2	±1.5(3σ)	±1.1(3σ)
Error⁵ (°C)	<±1.2(3σ)	<±1.5	-	-	-	-	-	-	-1.5~1.6	-	-0.4~0.6
Sensor power	-	-	-	-	-	-	-	-	0.92uW	-	1pJ**
Total power	3.78mW	1.4mW	-	1.6mW	0.4mW	0.6μW	0.5mW	0.4μW	-	3.6mW	-
Samples	50	5	-	750	15	16	20	61	64	80	40

Measurement Results



Conclusion

- Better sensors with *smaller* area, *higher* accuracy, and *lower* V_{DD} scalability are highly desirable
- A new temperature sensor architecture based on direct V_{TH} sensing is proposed
- The prototypes achieve 9× smaller footprint while having 3× better accuracy and 0.2V lower V_{DD} scalability down to 0.4V as compared to the previous state of arts